

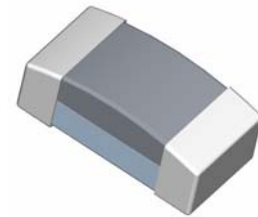
Specification Status: Released

BENEFITS

- ESD protection for high frequency applications (HDMI 1.3)
- Smaller form factor for board space savings
- Helps protect electronic circuits against damage from electrostatic discharge (ESD) events
- Assists equipment to pass IEC 61000-4-2, level 4 testing

FEATURES

- 0.25 pF (typ) Capacitance
- Low leakage current
- Low clamping voltage
- Fast response time (<1ns)
- Capable of withstanding numerous ESD strikes
- Compatible with standard reflow installation procedures
- Thick film technology
- Bi-directional protection



APPLICATIONS

- HDMI 1.3 interface
- LCD, HDTV
- Cellular phones
- Antennas (cell phones, GPS...)
- Portable video devices (PDA, DSC, Bluetooth...)
- Printer ports
- High speed Ethernet
- USB 2.0 and IEEE 1394 interfaces
- DVI interface

CAUTION: This device should not be used in Power Bus applications

MATERIALS INFORMATION

RoHS Compliant

Directive 2002/95/EC
Compliant

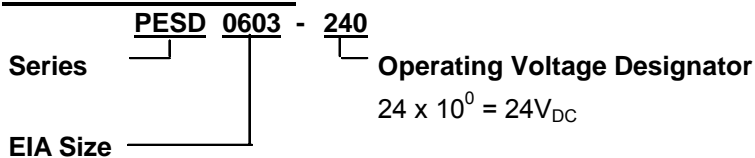
ELV Compliant

Directive 2000/53/EC
Compliant

Halogen Free*



PART NUMBERING



* Halogen Free refers to: Br≤900ppm, Cl≤900ppm, Br+Cl≤1500ppm

TYPICAL DEVICE RATINGS AND CHARACTERISTICS

| | Max Operating Voltage | Typical TLP Trigger Voltage ¹ | Typical TLP Clamping Voltage ¹ after 30ns | Typical Capacitance ² @ 1 MHz, 1V _{rms} | Typical Leakage Current @24V _{DC} | Max Leakage Current @24V _{DC} |
|--------|-----------------------|--|--|---|--|--|
| Symbol | V _{DC} | V _{T(TLP)} | V _{C(TLP 30)} | C _p | I _{L(Typ)} | I _{L(MAX)} |
| Unit | V | V | V | pF | μA | μA |
| Value | 24 | 215 | 45 | 0.25 | <0.01 | 10.0 |

Note 1: TLP test method at 1000V (refer to FIG. 5 on page 5)

Note 2: Typical capacitance @ 0V and 24V

GENERAL CHARACTERISTICS

Operating temperature: -55°C to +125°C

Storage temperature: -40°C to +85°C

ESD voltage capability (tested per IEC 61000-4-2)

- Contact discharge mode: 8kV (typ), 15kV (max)
- Air discharge mode: 15kV (typ), 25kV (max) [1 pulse: per customer request]

ESD pulse withstand: Typically 500 pulses (tested per IEC 61000-4-2, level 4, and contact method)

Environmental Specifications

| | Bias Humidity Test | Thermal Shock | Bias Heat Test | Bias Low Temp Test | Solderability | Solder Heat | Vibration | Mechanical Shock | Solvent Resistance |
|--------------------|---|--|--|--|------------------------------|--------------|---|--|--|
| Test Conditions | @ 85°C @ 85% RH V _{DC} (max) 1000 hours | -55°C to 125°C 30min dwell 1000 cycles | @ 125°C V _{DC} (max) 1000 hours | @ -55°C V _{DC} (max) 1000 hours | 250 °C +/- 5 °C 3s +/- 1s | 260 °C, 10s | 10 to 50Hz, 60s cycle, 2hrs each in X-Y-Z axis | 1500G, 0.5ms, X-Y-Z axis 3 times | IPA ultrasonic 300s |
| Pass/Fail Criteria | I _L ≤ 10μA | I _L ≤ 10μA | I _L ≤ 10μA | I _L ≤ 10μA | 95% coverage | 90% coverage | No Physical Damage I _L ≤ 10 μA | No Physical Damage I _L ≤ 10 μA | No Physical Damage I _L ≤ 10 μA |

FIG 1: CAPACITANCE VS. FREQUENCY (TYPICAL SAMPLE)

(PESD0603 Flat Response of Capacitance over Frequency Range)

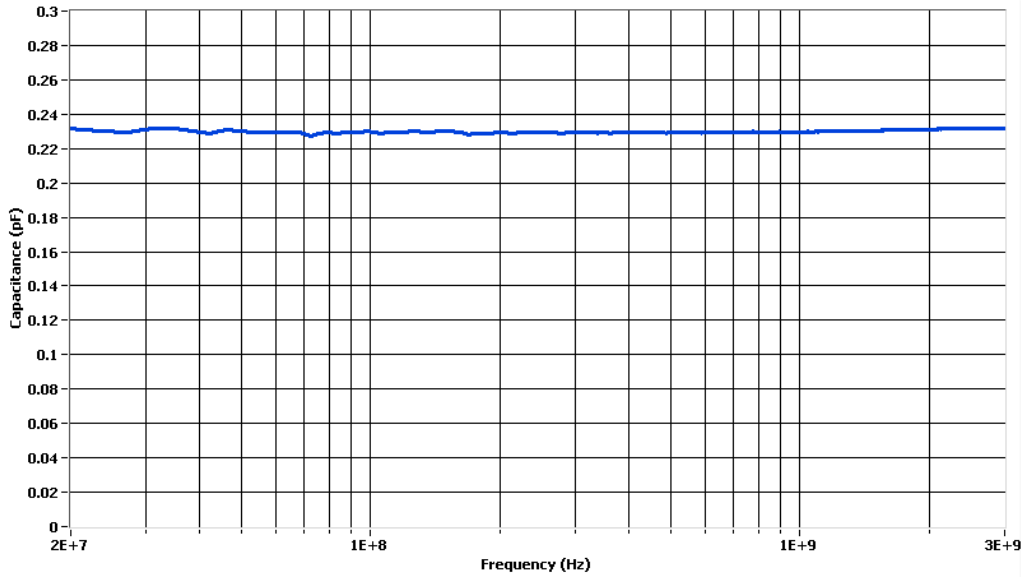


FIG 2: EYE DIAGRAM (TYPICAL SAMPLE)

(PESD0603 Eye Diagram Performance at 3.4 GHz— meets criteria for HDMI 1.3)

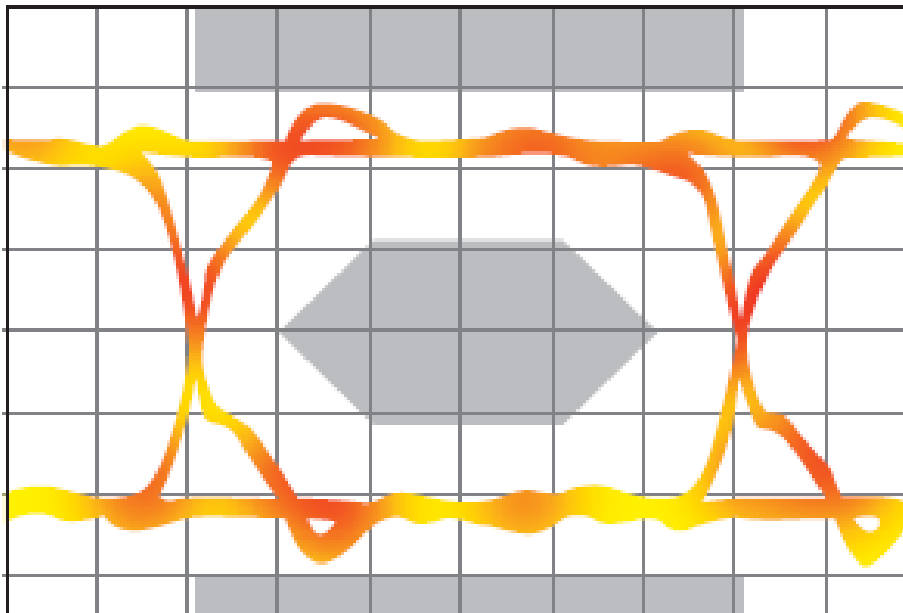


FIG 3: INSERTION LOSS DIAGRAM (TYPICAL SAMPLE) (PESD0603 Minimal Insertion Loss at 3.4 GHz)

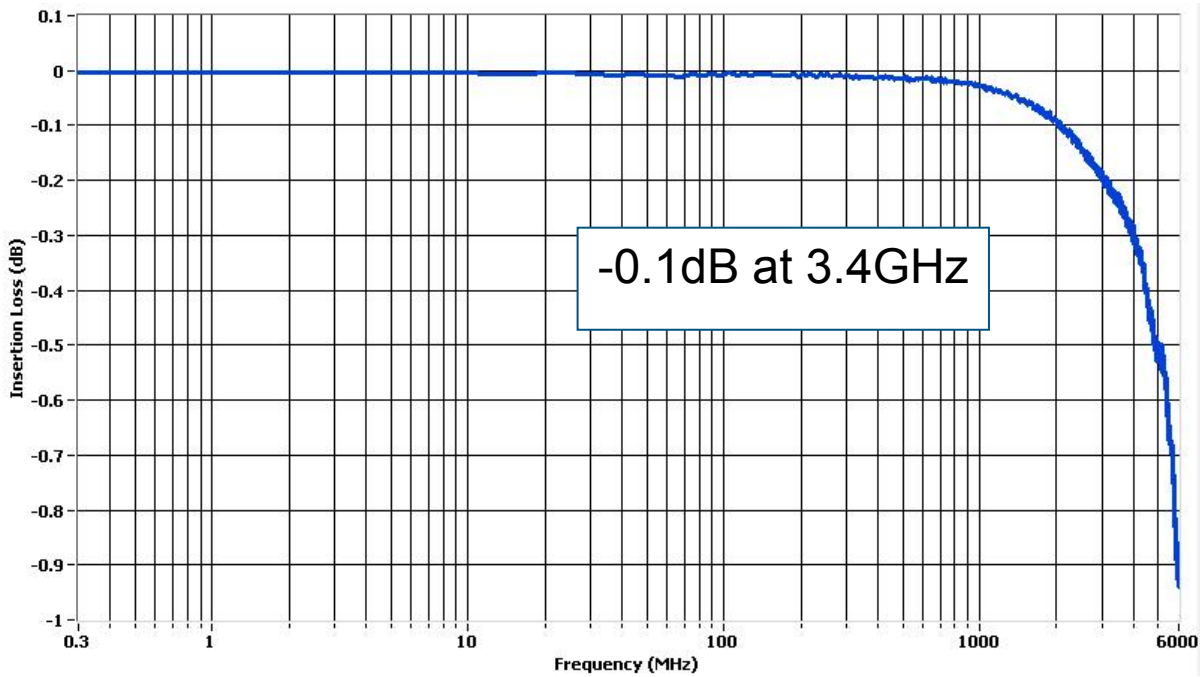


FIG 4: ESD PROTECTION FOR HDMI (PESD0603 Reference Layout and Test Results available)

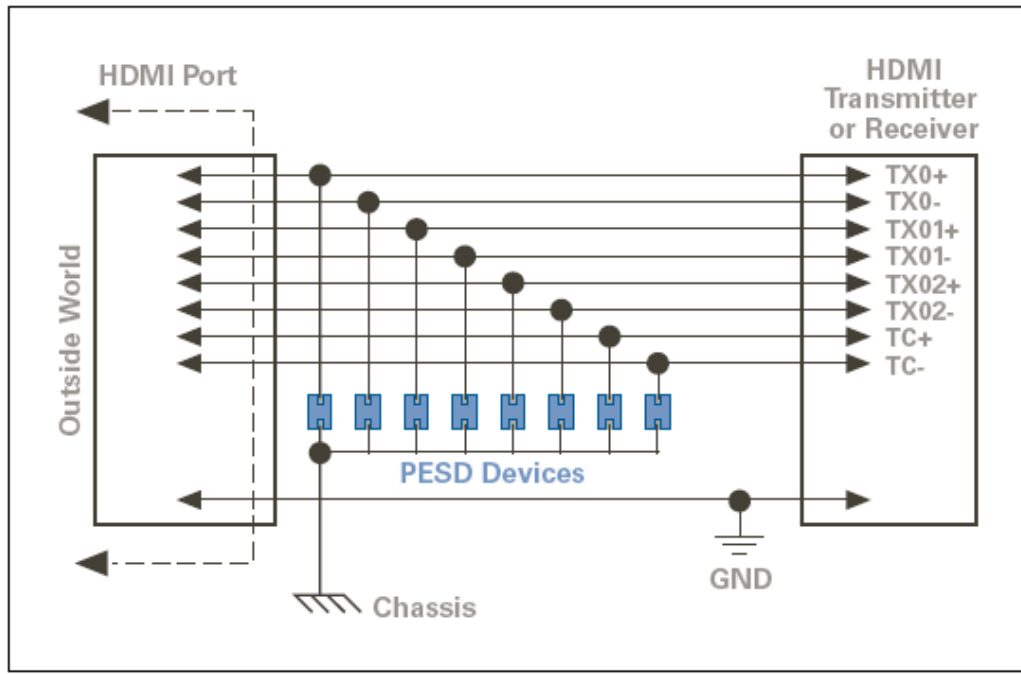
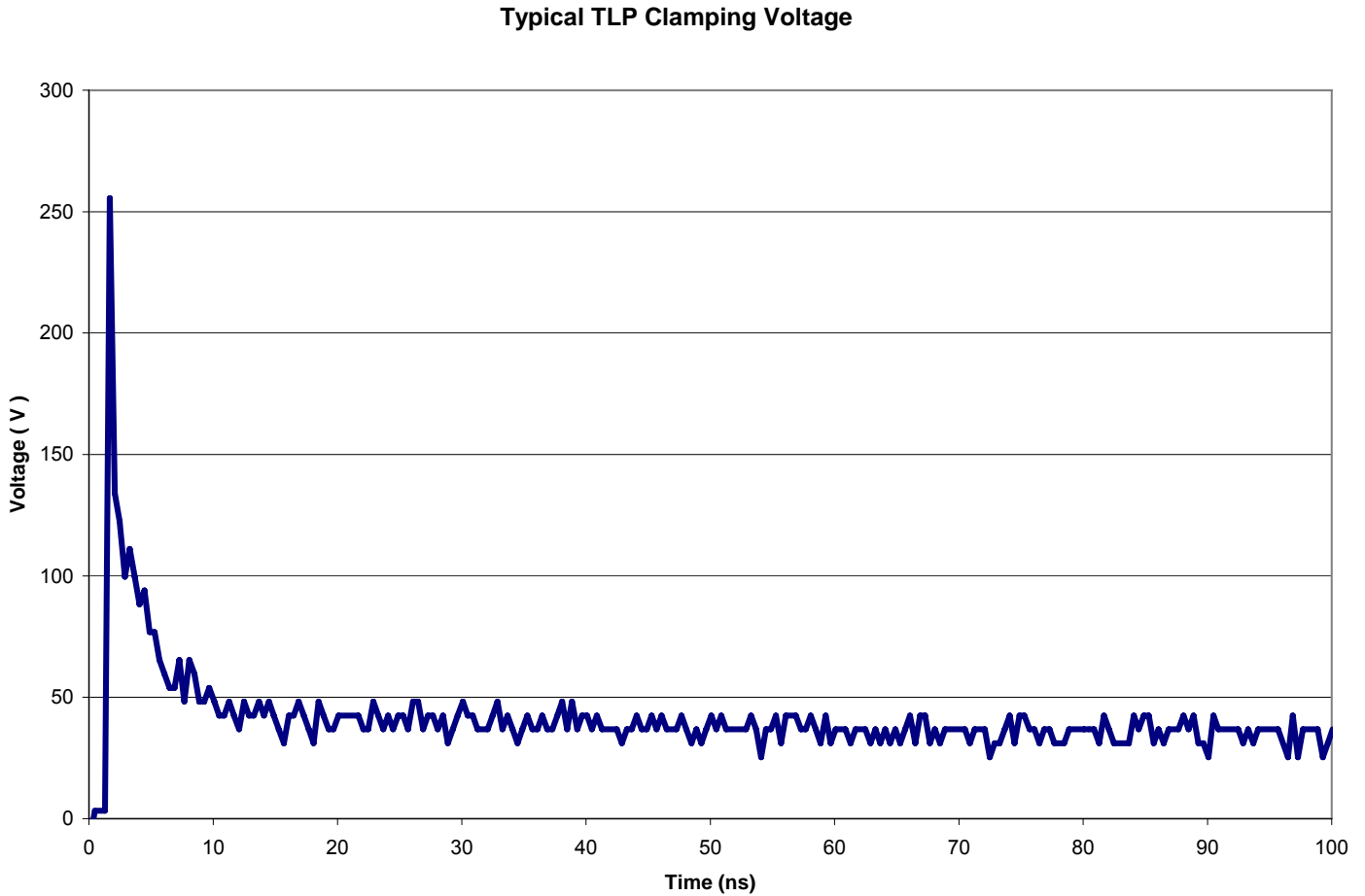
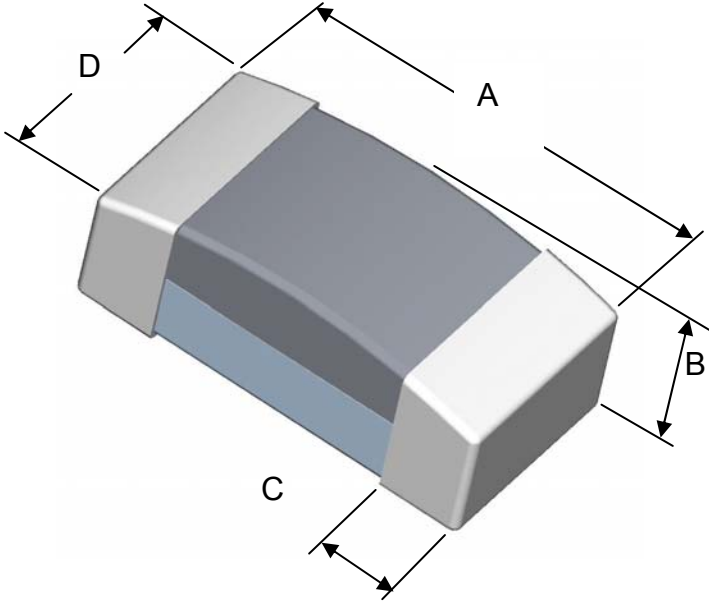


FIG 5: TYPICAL TRANSMISSION LINE PULSE RESPONSE GRAPH



DIMENSIONS



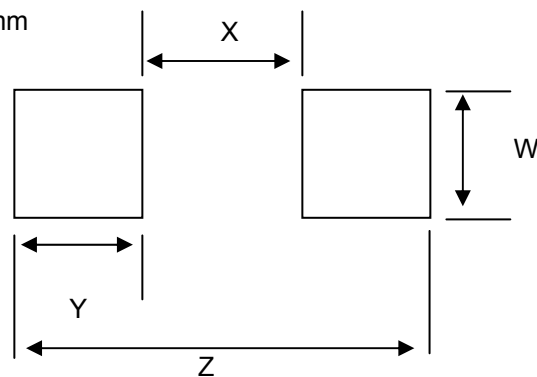
Drawing Not To Scale

| | Length A | | Height B | | Terminal Width C | | Width D | |
|-----|----------|---------|----------|---------|------------------|---------|---------|---------|
| | Min | Max | Min | Max | Min | Max | Min | Max |
| mm | 1.50 | 1.70 | 0.45 | 0.55 | 0.10 | 0.50 | 0.70 | 1.00 |
| in* | (0.059) | (0.067) | (0.018) | (0.022) | (0.004) | (0.020) | (0.028) | (0.039) |

* Round off approximation

RECOMMENDED LAND PATTERN:

Solder thickness 0.15 to 0.2mm

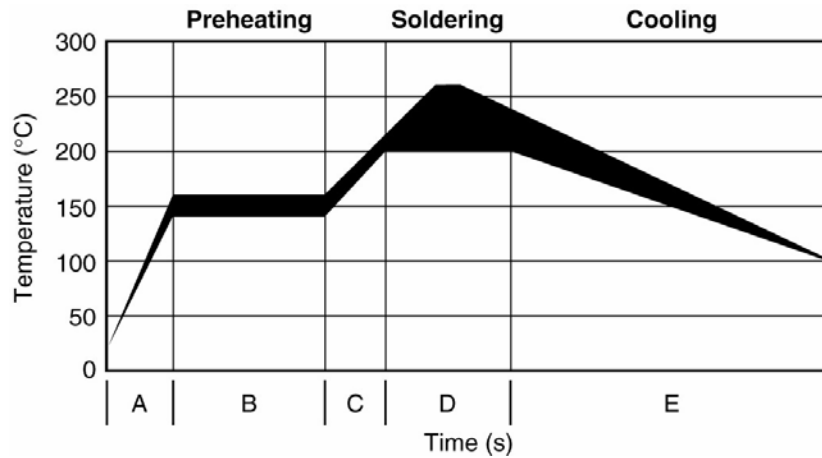


| | W | | X | | Y | | Z | |
|-----|---------|---------|---------|---------|---------|---------|---------|---------|
| | Min | Max | Min | Max | Min | Max | Min | Max |
| mm | 0.90 | 1.00 | 0.50 | 0.60 | 1.00 | 1.10 | 2.70 | 2.80 |
| in* | (0.035) | (0.039) | (0.020) | (0.024) | (0.039) | (0.043) | (0.106) | (0.110) |

* Round off approximation

SOLDER REFLOW RECOMMENDATIONS:

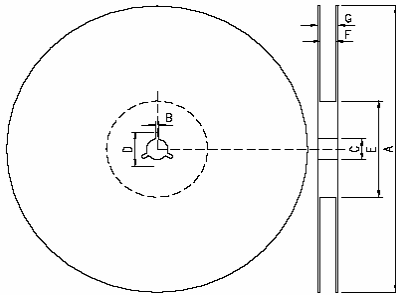
| | | | |
|---|-----------------------|--|---|
| A | Temperature ramp up 1 | From ambient to Preheating temperature | 30s to 60s |
| B | Preheating | 140°C - 160°C | 60s to 120s |
| C | Temperature ramp up 2 | From Preheating to Main heating temperature | 20s to 40s |
| D | Main heating | at 200°C at 220°C at 240°C at 260°C | 60s ~ 70s 50s ~ 60s 30s ~ 40s 5s ~ 10s |
| E | Cooling | From main heating temperature to 100°C | max 4°C/s |



PACKAGING

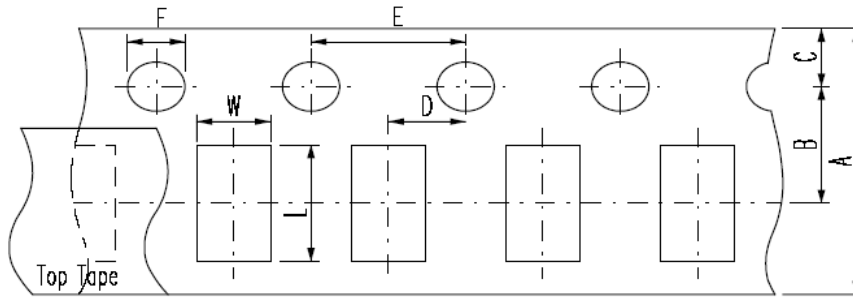
| Packaging | Tape & Reel | Standard Box |
|--------------|-------------|--------------|
| PESD0603-240 | 5,000 | 25,000 |

EIA referenced Reel Dimensions for PESD Devices



Reel Dimensions (mm):

| | A | B | C | D | E | F | G |
|---------------------|------------|----------|-----------|-----------|-----------|----------|-----------|
| 0603 Devices | 178.0 ±2.0 | 2.0 ±0.5 | 13.0 ±0.5 | 21.0 ±0.8 | 62.0 ±1.5 | 9.0 ±0.5 | 13.0 ±1.0 |



Carrier Dimensions (mm):

| | A | B | C | D | E | F | L | W | T ¹ |
|---------------------|----------|-----------|-----------|-----------|----------|----------|------------|------------|----------------|
| 0603 Devices | 8.0 ±0.3 | 3.5 ±0.05 | 1.75 ±0.1 | 2.0 ±0.05 | 4.0 ±0.1 | 1.5 ±0.1 | 2.02 ±0.20 | 1.27 ±0.15 | 0.60 ±0.03 |

Note 1: Carrier thickness

Product Orientation – always face up (meaning the substrate is at the bottom), but parts do not have polarity mark.

Leader & Trailer: The leader is 180mm in length & consists of empty cavities with sealed cover tape.
 The trailer is 350mm in length & consists of empty cavities with sealed cover tape.

POST REFLOW, CLEANING CONDITIONS

A 5% saponifier combined with water during wash.

For the ultrasonic process water temperature should be at 50°C and board should be submerged for a minimum of one minute in the solutions, then rinse and dry.

For in-line washing, the temperature of the water sprayed should be at 110°C, rinse and drying is done in-line.



WARNING

Warning: Application Limitations for PESD0603-240. This part is not intended to be used on power lines or for power bus applications. Users should independently evaluate the suitability of and test each product selected for their own applications

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